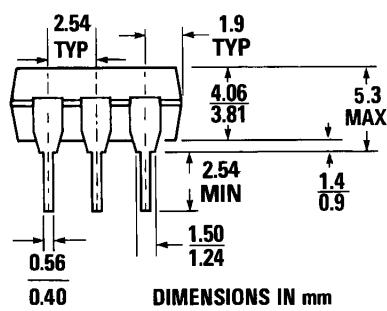
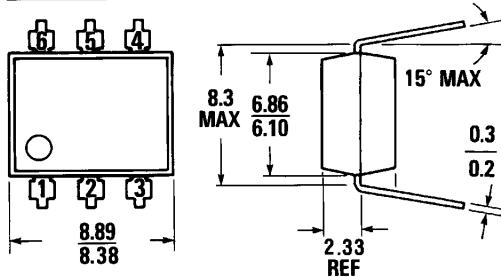


PACKAGE DIMENSIONS



DIMENSIONS IN mm
PACKAGE CODE K

ST1603A

DESCRIPTION

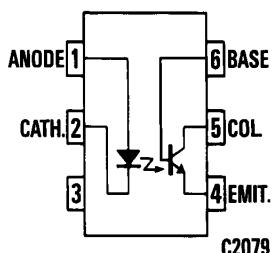
The MCT270 is a phototransistor-type optically coupled isolator. A gallium arsenide infrared emitting diode is selectively coupled with an NPN silicon phototransistor.

FEATURES

- Minimum current transfer ratio of 50%
- Maximum turn-on, turn-off time 10 μ seconds specified
- Underwriters Laboratory (UL) recognized File E90700

APPLICATIONS

- Power supply regulators
- Digital logic inputs
- Microprocessor inputs
- Appliance sensor systems
- Power supply regulators
- Industrial controls



Equivalent Circuit

ABSOLUTE MAXIMUM RATINGS

TOTAL PACKAGE

Storage temperature	-55°C to 150°C
Operating temperature	-55°C to 100°C
Lead tempertaure (soldering , 10 sec)	260°C
Total package power dissipation @ 25 (LED plus detector)	260 mW
Derate linearly from 25°C	3.5 mW/°C

INPUT DIODE

Forward DC current	90 mA
Reverse voltage	3 V
Peak forward current (1 μ s pulse, 300 pps)	3.0 A
Power dissipation 25°C ambient	135 mW
Derate linearly from 25°C	1.8 mW/°C

OUTPUT TRANSISTOR

Power dissipation @ 25°C	200 mW
Derate linearly from 25°C	2.67 mW/°C



PHOTOTRANSISTOR OPTOCOUPLES

ELECTRO-OPTICAL CHARACTERISTICS (25°C Temperature Unless Otherwise Specified)

INDIVIDUAL COMPONENT CHARACTERISTICS

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
INPUT DIODE						
Forward voltage	V_F		1.3	1.50	V	$I_F=20 \text{ mA}$
Forward voltage temp. coefficient	$\frac{\Delta V_F}{\Delta T_A}$		-1.8		mV/°C	
Reverse voltage	V_R	3.0	25		V	$I_R=10 \mu\text{A}$
Junction capacitance	C_J		50 65		pF	$V_F=0 \text{ V}, f=1 \text{ MHz}$ $V_F=1 \text{ V}, f=1 \text{ MHz}$
Reverse leakage current	I_R		0.35	10	μA	$V_R=3.0 \text{ V}$
OUTPUT TRANSISTOR						
DC forward current gain	h_{FE}	100	500			$V_{CE}=5 \text{ V}, I_c=100 \mu\text{A}$
Breakdown voltage Collector to emitter	BV_{CEO}	30	45		V	$I_C=1.0 \text{ mA}, I_F=0$
Collector to base	BV_{CBO}	70	130		V	$I_C=10 \mu\text{A}, I_F=0$
Emitter to base	BV_{EBO}	5	7		V	$I_E=100 \mu\text{A}, I_F=0$
Leakage current Collector to emitter	I_{CEO}		5	50	nA	$V_{CE}=10 \text{ V}, I_F=0$
Collector to base	I_{CBO}			20	nA	$V_{CB}=10 \text{ V}, I_F=0$
Capacitance Collector to emitter			8		pF	$V_{CE}=0, f=1 \text{ MHz}$
Collector to base			20		pF	$V_{CB}=5, f=1 \text{ MHz}$
Emitter to base			10		pF	$V_{EB}=0, f=1 \text{ MHz}$

TRANSFER CHARACTERISTICS

DC CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Current transfer ratio, collector to emitter	CTR_{CE}	50	115		%	$I_F=10 \text{ mA}; V_{CE}=10 \text{ V}$
Current transfer ratio, collector to base	CTR_{CB}	0.045	0.15		%	$I_F=16 \text{ mA}; V_{CB}=10 \text{ V}$
Saturation voltage	$V_{CE(\text{SAT})}$.21	.40	V	$I_F=10 \text{ mA}; I_C=2 \text{ mA}$

TRANSFER CHARACTERISTICS

CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
SWITCHING TIMES						
Non-saturated Turn-on time	t_{on}		6.0	10	μs	$R_L=100\Omega; I_C=2 \text{ mA}; V_{CC}=5 \text{ V}$
Turn-off time	t_{off}		5.5	10	μs	See Figs. 10, 11
Saturated Turn-on time	t_{on}		3.9		μs	$I_F=16 \text{ mA}; R_L=1.9 \text{ k}\Omega$
Turn-off time	t_{off}		48		μs	See Figs. 10, 11
(Approximates a typical TTL interface) Turn-on time	t_{on}		3.9		μs	$I_F=16 \text{ mA}; R_L=4.7 \text{ k}\Omega$
Turn-off time (Approximates a typical low power TTL interface)	t_{off}		110		μs	See Figs. 10, 11



PHOTOTRANSISTOR OPTOCOUPLER

ELECTRO-OPTICAL CHARACTERISTICS

(25°C Temperature Unless Otherwise Specified) (Cont'd)

ISOLATION CHARACTERISTICS

CHARACTERISTICS	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Steady state isolation	V_{iso}	7500		VAC-PEAK	$I_{io} \leq 1 \mu A$, 1 minute	
		5300		VAC-rms	$I_{io} \leq 1 \mu A$, 1 minute	
Isolation resistance	R_{iso}	10^{11}		ohms	$V_{io}=500$ VDC	
Isolation capacitance	C_{iso}	0.5		pF	$f=1$ MHz	

TYPICAL ELECTRICAL CHARACTERISTIC CURVES

(25°C Free Air Temperature Unless Otherwise Specified)

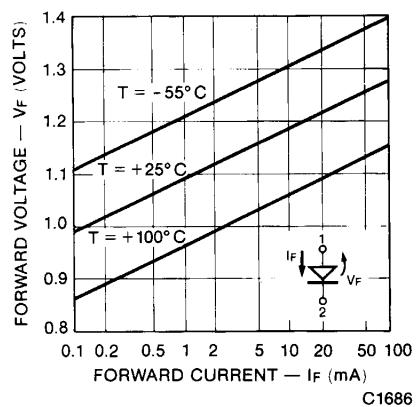


Fig. 1. Forward Voltage vs.
Current

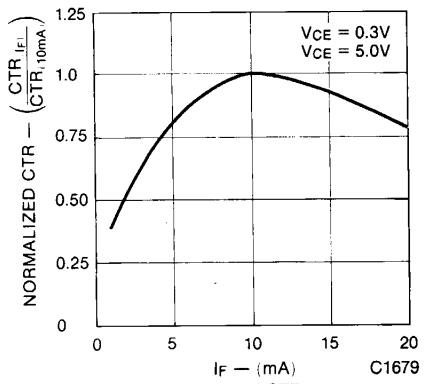


Fig. 2. Normalized CTR vs.
Forward Current

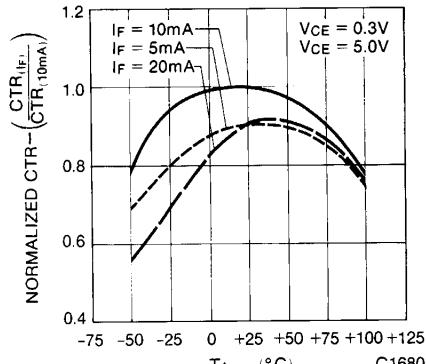


Fig. 3. Normalized CTR vs.
Temperature

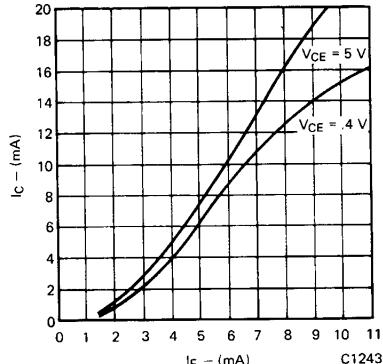


Fig. 4. Collector Current vs.
Forward Current

TYPICAL ELECTRICAL CHARACTERISTIC CURVES
(25°C Free Air Temperature Unless Otherwise Specified) (Cont'd)

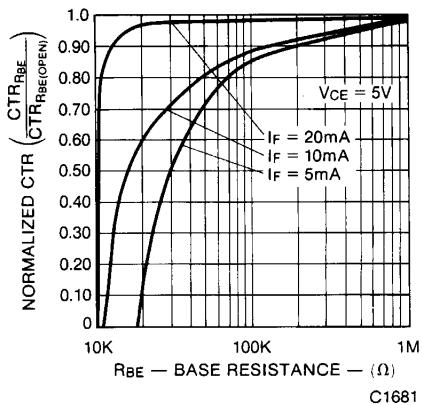


Fig. 5. CTR vs. RBE (Unsaturated)

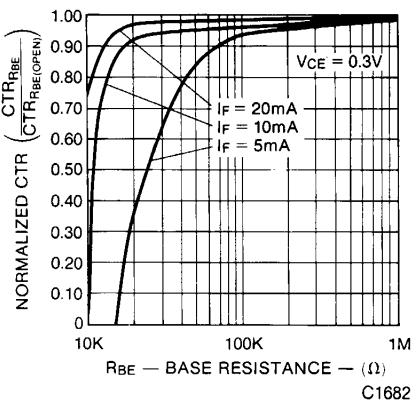


Fig. 6. CTR vs. RBE (Saturated)

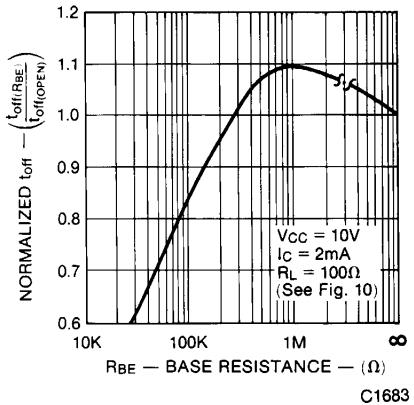


Fig. 7. Normalized T_{off} vs. RBE

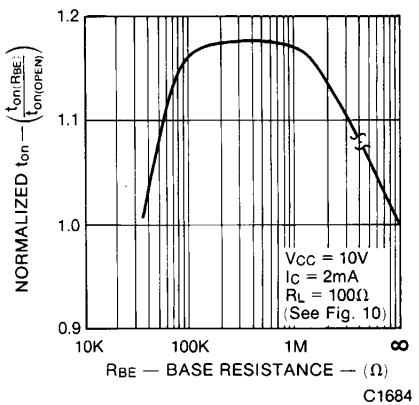


Fig. 8. Normalized T_{on} vs. RBE

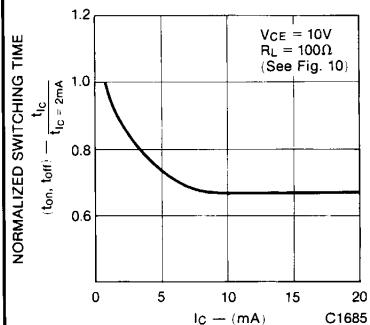


Fig. 9. Switching Time vs. IC

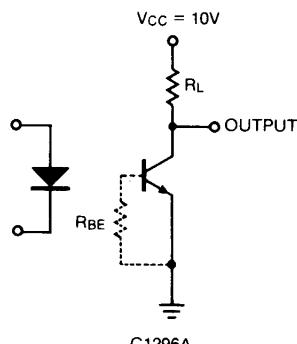


Fig. 10. Switching Time Test Circuit

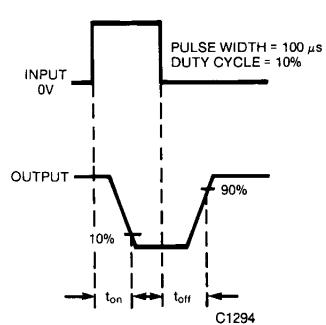


Fig. 11. Switching Time Waveforms



PHOTOTRANSISTOR OPTOCOUPLES

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